PRODUCT FEATURES

☐ IGBT^3 Chip(Trench+Field Stop technology)

☐ Low switching losses

☐ $V_{CE(sat)}$ with positive temperature coefficient

☐ Fast switching and short tail current

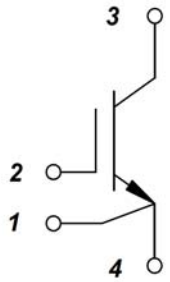
☐ Popular SOT-227 Package

APPLICATIONS

☐ AC motor control

☐ Motion/servo control

☐ Inverter and power supplies



IGBT

ABSOLUTE MAXIMUM RATINGS(T_C=25°C unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	T_J=25℃	1200	V
V_{GES}	Gate Emitter Voltage		±20	
I_C	DC Collector Current	T_C=25℃,T_{Jmax}=150℃	200	A
		T_C=80℃,T_{Jmax}=150℃	150	
I_{CM}	Repetitive Peak Collector Current	tp=1ms	300	
P_{tot}	Power Dissipation Per IGBT	T_C=25℃,T_{Jmax}=150℃	690	W

MODULE CHARACTERISTICS(T_C=25°C unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
T_{Jmax}	Max. Junction Temperature		150	°C
T_{Jop}	Operating Temperature		-40~125	
T_{stg}	Storage Temperature		-40~125	
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000	V
Torque	to heatsink	Recommended（M4）	0.7~1.1	Nm
	to terminal	Recommended（M4）	0.7~1.1	Nm
Weight			26.5	g

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ELECTRICAL CHARACTERISTICS *(T_C =25°C unless otherwise specified)*

Symbol	Parameter/Test Conditions			Min.	Typ.	Max.	Unit
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}$, I_C=6mA		5	5.8	6.5	V
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	I_C=150A, V_{GE}=15V, T_J=25°C			1.7	2.15	
		I_C=150A, V_{GE}=15V, T_J=125°C			1.9		
I_{CES}	Collector Leakage Current	V_{CE}=1200V, V_{GE}=0V, T_J=25°C				100	μA
		V_{CE}=1200V, V_{GE}=0V, T_J=125°C				1	mA
I_{GES}	Gate Leakage Current	V_{CE}=0V,V_{GE}=±15V, T_J=25°C		-400		400	nA
R_{gint}	Integrated Gate Resistor				5		Ω
Q_g	Gate Charge	V_{CE}=600V, I_C=150A , V_{GE}=±15V			1.4		μC
C_{ies}	Input Capacitance	V_{CE}=25V, V_{GE}=0V, f =1MHz			10.5		nF
C_{res}	Reverse Transfer Capacitance				0.4		nF
$t_{d(on)}$	Turn on Delay Time	V_{CC}=600V,I_C=150A R_G =2.4Ω, V_{GE}=±15V, Inductive Load	T_J=25°C		260		ns
			T_J=125°C		290		ns
t_r	Rise Time		T_J=25°C		30		ns
			T_J=125°C		50		ns
$t_{d(off)}$	Turn off Delay Time	V_{CC}=600V,I_C=150A R_G =2.4Ω, V_{GE}=±15V, Inductive Load	T_J=25°C		420		ns
			T_J=125°C		520		ns
t_f	Fall Time		T_J=25°C		70		ns
			T_J=125°C		90		ns
E_{on}	Turn on Energy	V_{CC}=600V,I_C=150A R_G =2.4Ω, V_{GE}=±15V, Inductive Load	T_J=25°C		12		mJ
			T_J=125°C		16		mJ
E_{off}	Turn off Energy		T_J=25°C		11		mJ
			T_J=125°C		14.5		mJ
I_{SC}	Short Circuit Current	tpsc≤10μS , V_{GE}=15V T_J=125°C,V_{CC}=600V			600		A
R_{thJC}	Junction to Case Thermal Resistance （ Per IGBT）					0.18	K /W

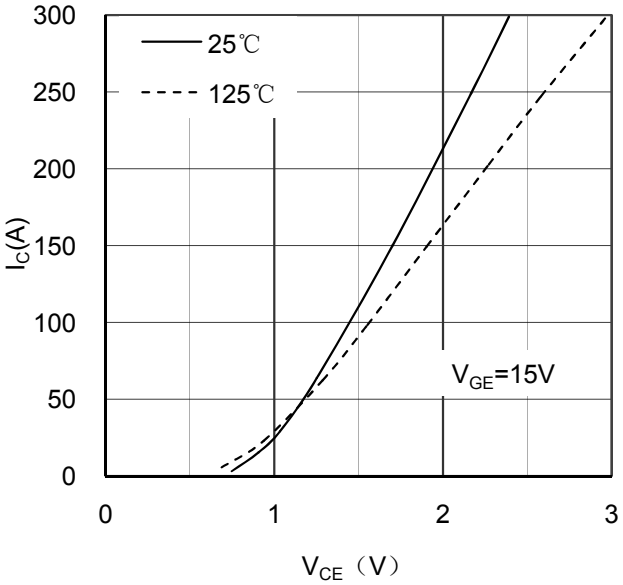

Figure 1. Typical Output Characteristics IGBT

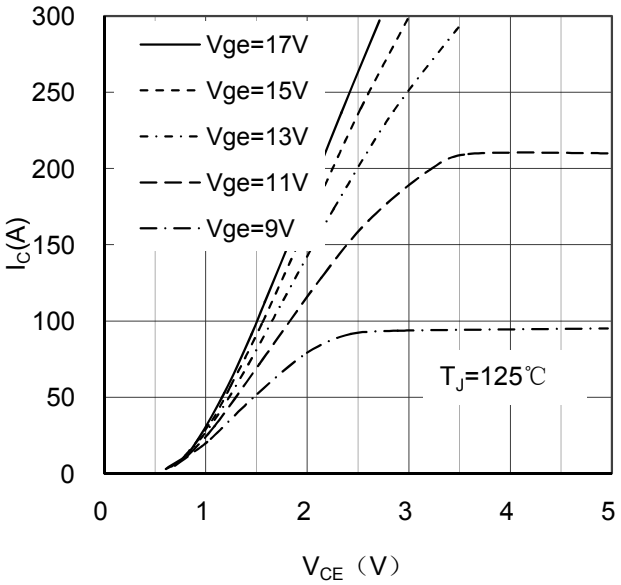

Figure 2. Typical Output Characteristics IGBT

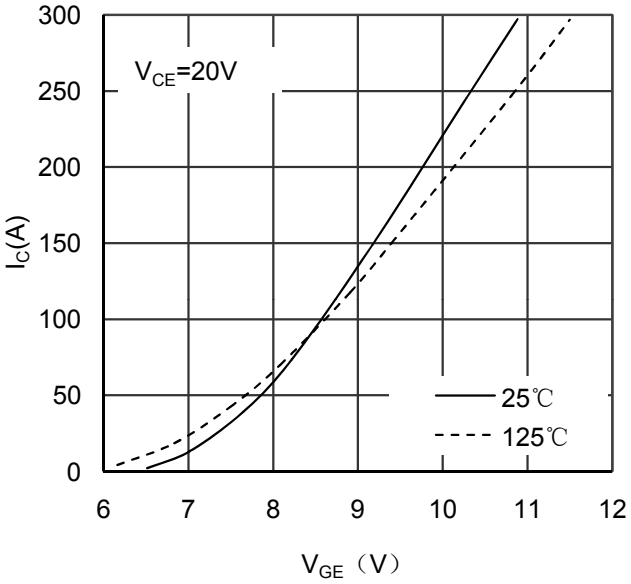

Figure 3. Typical Transfer characteristics IGBT

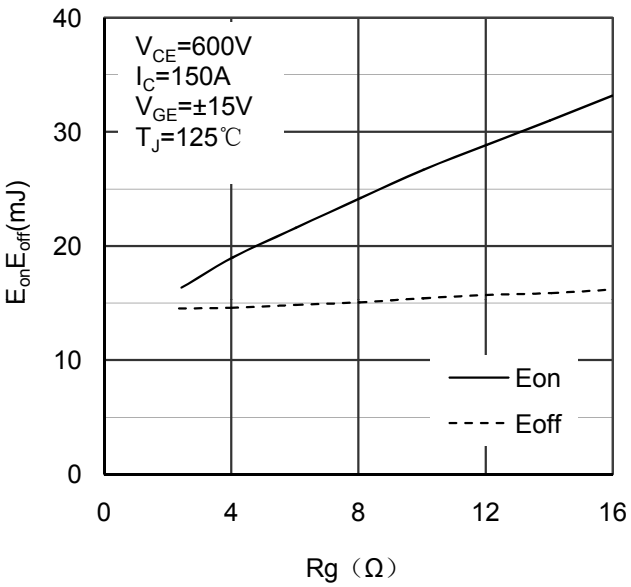

Figure 4. Switching Energy vs Gate Resistor IGBT

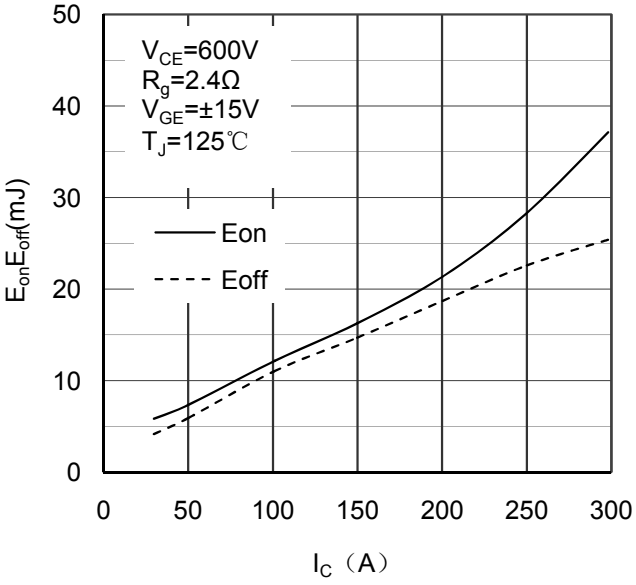

Figure 5. Switching Energy vs Collector Current IGBT

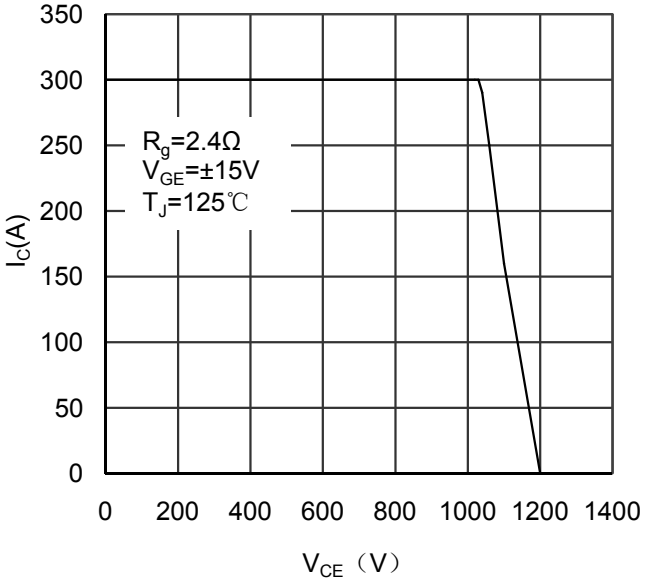

Figure 6. Reverse Biased Safe Operating Area IGBT

MMG150J120UZ6TN

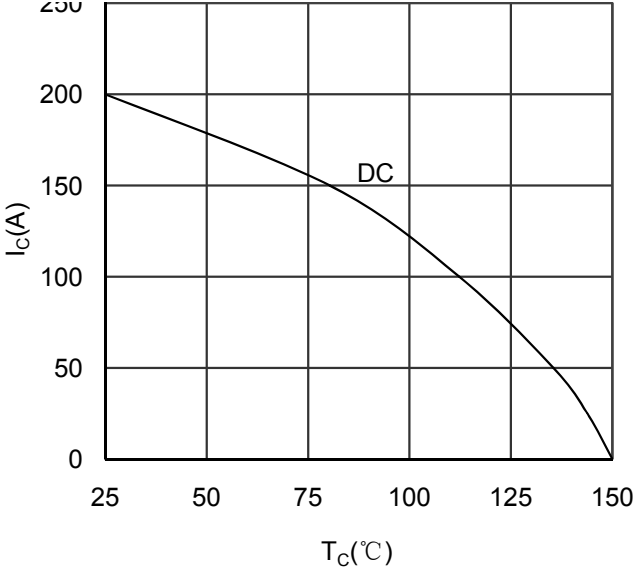

Figure 7. Collector Current vs Case temperature
IGBT

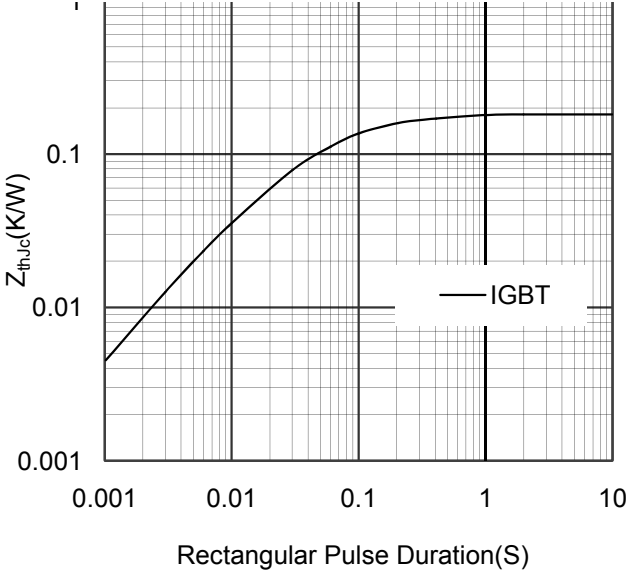

Figure 8. Transient Thermal Impedance of
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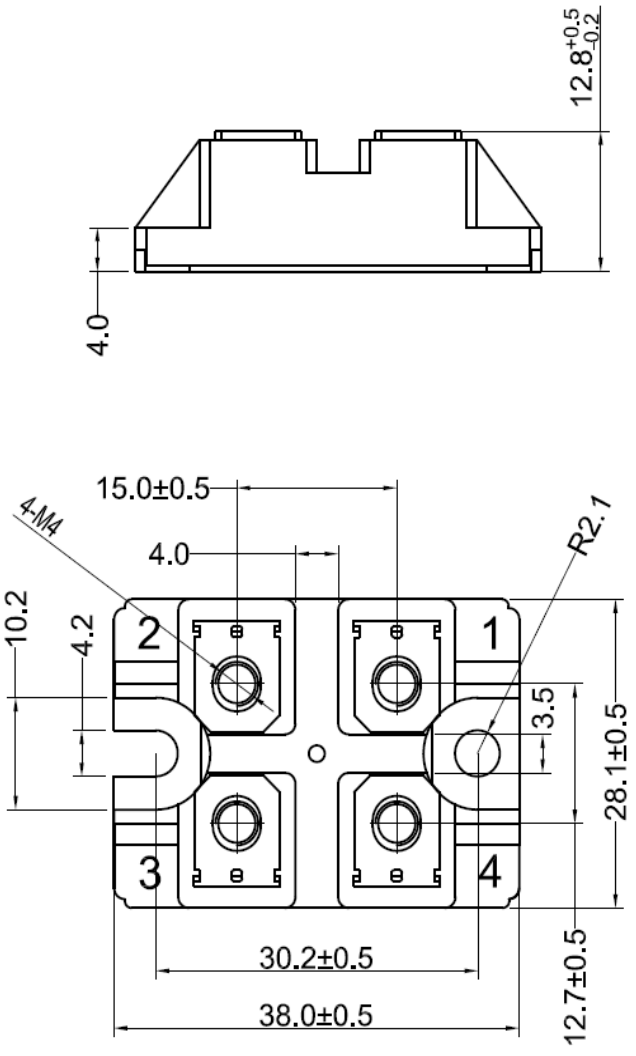

Dimensions in (mm)
Figure 9. Package Outline